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SEMICONDUCTOR®

October 2013

FQB33N10 — N-Channel QFET[®] MOSFET

FQB33N10 N-Channel QFET[®] MOSFET

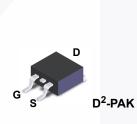
100 V, 33 A, 52 m Ω

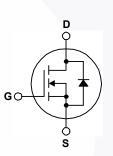
Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

Features

- 33 A, 100 V, ${\sf R}_{{\sf DS}({\sf on})}$ = 52 m Ω (Max) @V_{{\sf GS}} = 10 V, ${\sf I}_{{\sf D}}$ = 16.5 A
- Low Gate Charge (Typ. 38 nC)
- Low Crss (Typ. 62 pF)
- 100% Avalanche Tested
- 175°C Maximum Junction Temperature Rating





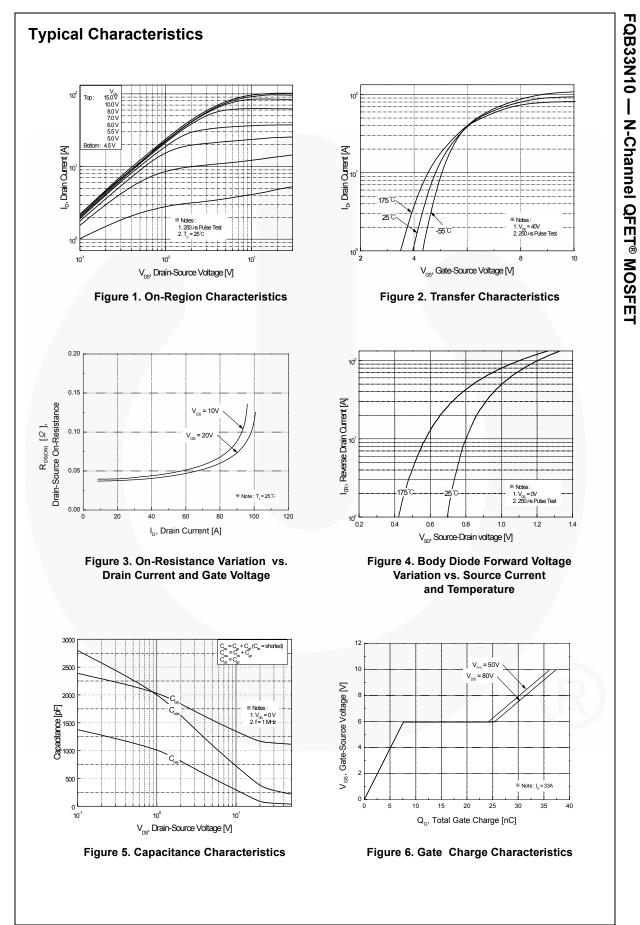
Absolute Maximum Ratings T_c = 25°C unless otherwise noted

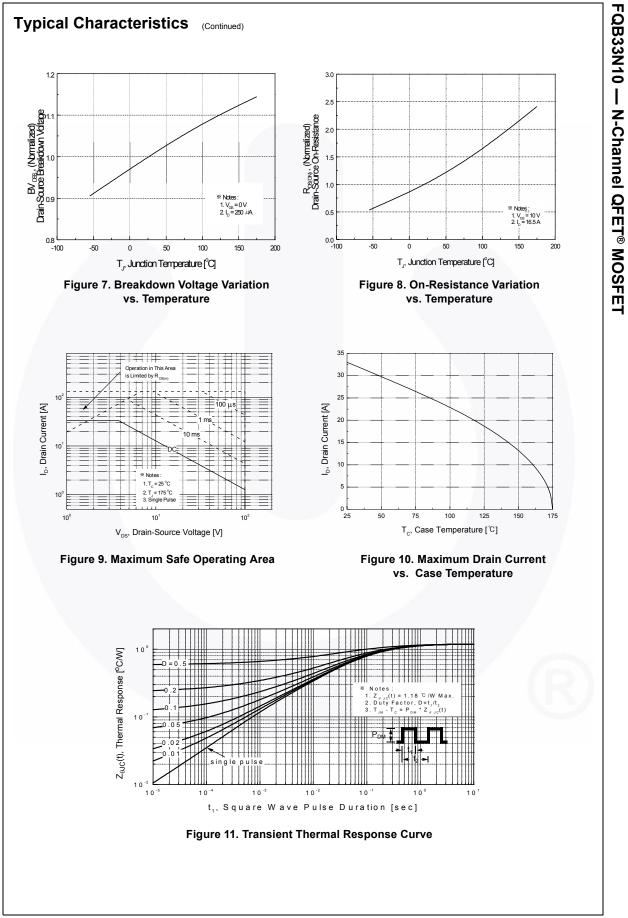
Symbol	Parameter		FQB33N10TM	Unit
V _{DSS}	Drain-Source Voltage		100	V
I _D	Drain Current - Continuous ($T_c = 25^{\circ}C$)		33	A
	- Continuous (T _C = 100	O°C)	23	A
I _{DM}	Drain Current - Pulsed	(Note 1)	132	A
V _{GSS}	Gate-Source Voltage		± 25	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	435	mJ
I _{AR}	Avalanche Current	(Note 1)	33	A
E _{AR}	Repetitive Avalanche Energy	(Note 1)	12.7	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	6.0	V/ns
PD	Power Dissipation $(T_A = 25^{\circ}C)^{*}$		3.75	W
-	Power Dissipation ($T_c = 25^{\circ}C$)		127	W
	- Derate above 25°C		0.85	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +175	°C
Τ _L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

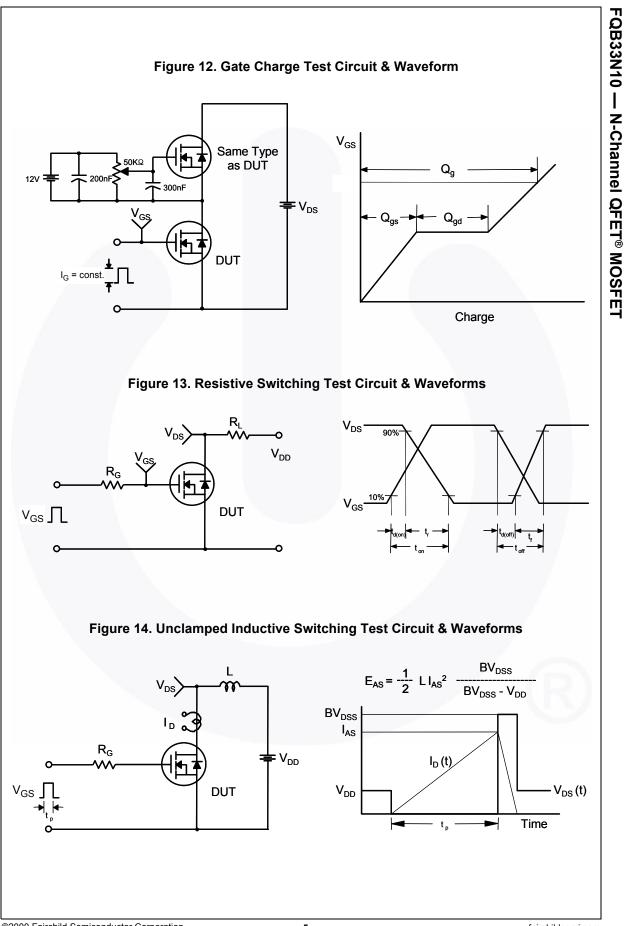
Thermal Characteristics

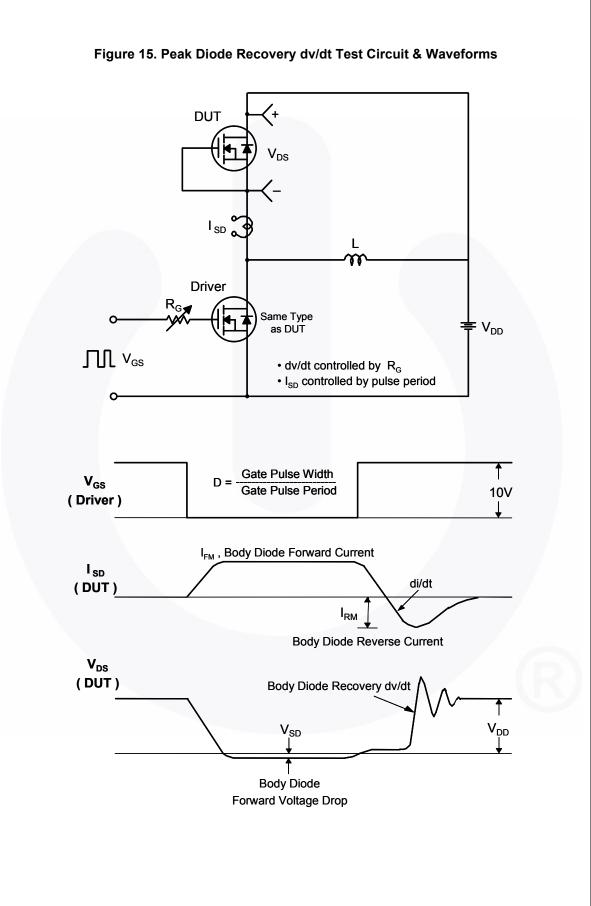
Symbol	Parameter	FQB33N10TM	Unit	
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max. 1.18			
Rou	Thermal Resistance, Junction to Ambient (minimum pad of 2 oz copper), Max.	62.5	°C/W	
	Thermal Resistance, Junction to Ambient (* 1 in ² pad of 2 oz copper), Max.	40		

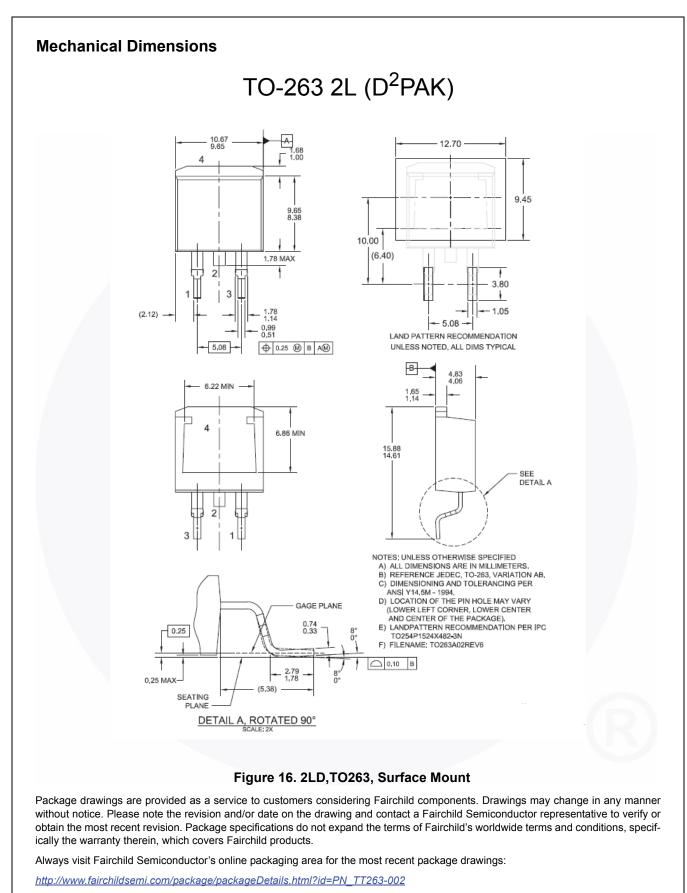
Device MarkingDeviceFQB33N10FQB33N10TM		Device	Package	R	eel Size		Tape Wi	dth	Quantity
		D2-PAK 330mm			24mm	ı	800		
lectric	cal Char	acteristics T _c = 25°C	unless otherwise noted						
Symbol		Parameter	i	nditions		Min	Тур	Мах	Unit
	rootorioti								
	racteristi		$\lambda = 0 \lambda + z$	250 4		100			V
BV _{DSS} ∆BV _{DSS}		ce Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA		100			V	
ΔΒν _{DSS} / ΔΤ _J	Coefficient	Voltage Temperature	I_D = 250 μ A, Referenced to 25°C			0.11		V/°C	
DSS	Zero Gate Voltage Drain Current		V _{DS} = 100 V, V _C	-				1	μA
			V _{DS} = 80 V, T _C = 150°C				10	μA	
GSSF	Gate-Body	Leakage Current, Forward	V_{GS} = 25 V, V_{DS}					100	nA
GSSR	Gate-Body	Leakage Current, Reverse	V_{GS} = -25 V, V_{D}	_S = 0 V				-100	nA
	ve et evieti								
	racteristi			250 4				4.0	
V _{GS(th)}		shold Voltage	$V_{DS} = V_{GS}, I_D =$	250 μΑ		2.0		4.0	V
R _{DS(on)}	Static Drair On-Resista		$V_{GS} = 10 V, I_{D} = 16.5 A$			0.040	0.052	Ω	
9fs	Forward Transconductance $V_{DS} = 40 \text{ V}, I_D = 16.5 \text{ A}$				22		S		
Dvnami	ic Charac	teristics							
				- 0.1/			1150	1500	pF
C _{oss}	Output Cap		V _{DS} = 25 V, V _{GS} = 0 V, f = 1.0 MHz			320	420	pF	
C _{rss}		ansfer Capacitance				62	80	pF	
							I		
	ng Chara								_
d(on)	Turn-On De	,	V _{DD} = 50 V, I _D =	33 A,			15	40	ns
r r	Turn-On Ri		R _G = 25 Ω				195	400	ns
d(off)	Turn-Off De	,				80	170	ns	
f	Turn-Off Fa				(Note 4)		110	230	ns
ପ _g	Total Gate	•	V _{DS} = 80 V, I _D =	33 A,			38	51	nC
ସୁ _{gs}	Gate-Source	0	V _{GS} = 10 V		(Note 4)		7.5		nC
Q _{gd}	Gate-Drain	Charge			(14018 4)		18		nC
Drain-S	ource Dic	ode Characteristics ar	nd Maximum I	Ratings					
s	Maximum Continuous Drain-Source Diode Forward Current						33	Α	
sм	Maximum I	Pulsed Drain-Source Diode F	Forward Current				132	Α	
V _{SD}	Drain-Sour	ce Diode Forward Voltage	V_{GS} = 0 V, I_{S} = 3	33 A				1.5	V
t _{rr}	Reverse R	ecovery Time	V_{GS} = 0 V, I_{S} = 3	33 A,			80		ns
Q _{rr}	Reverse R	ecovery Charge	dl _F / dt = 100 A/	us			0.22		μC
L = 0.6mH, I $I_{SD} \le 33A$, α	_{AS} = 33A, V _{DD} = di/dt ≤ 300A/µs,	th limited by maximum junction temper 25V, R_G = 25 Ω , Starting $~T_J$ = 25°C V_{DD} \leq BV _{DSS} , Starting $~T_J$ = 25°C verating temperature	ature						











Dimension in Millimeters



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			XS™

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